

General Description

The GreenMOS® high voltage MOSFET utilizes charge balance technology to achieve outstanding low on-resistance and lower gate charge. It is engineered to minimize conduction loss, provide superior switching performance and robust avalanche capability.

The GreenMOS® Generic series is optimized for extreme switching performance to minimize switching loss. It is tailored for high power density applications to meet the highest efficiency standards.

Features

- Low $R_{DS(ON)}$ & FOM
- Extremely low switching loss
- Excellent stability and uniformity
- EMI and performance balanced



Applications

- LED lighting
- Charger
- Adapter
- TV power
- Telecom power
- Server power
- Solar/UPS

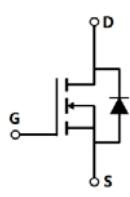
Key Performance Parameters

Parameter	Value	Unit
V_{DS} , min @ $T_j(max)$	700	V
I_D , pulse	13.5	A
$R_{DS(ON)}$, max @ $V_{GS}=10V$	1.2	mΩ
Q_g	7	nC

Marking Information

Product Name	Package	Marking
OSG07N65AF	TO251	OSG07N65A

Package & Pin Information



Absolute Maximum Ratings at $T_j=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-source voltage	V_{DS}	650	V
Gate-source voltage	V_{GS}	± 30	V
Continuous drain current ¹⁾ , $T_c=25^\circ\text{C}$	I_D	4.5	A
Continuous drain current ¹⁾ , $T_c=100^\circ\text{C}$		2.8	
Pulsed drain current ²⁾ , $T_c=25^\circ\text{C}$	$I_{D, \text{pulse}}$	13.5	A
Continuous diode forward current ¹⁾ , $T_c=25^\circ\text{C}$	I_S	4.5	A
Diode pulsed current ²⁾ , $T_c=25^\circ\text{C}$	$I_{S, \text{pulse}}$	13.5	A
Power dissipation ³⁾ , $T_c=25^\circ\text{C}$	P_D	28.4	W
Single pulsed avalanche energy ⁵⁾	E_{AS}	100	mJ
MOSFET dv/dt ruggedness, $V_{DS}=0\dots 480\text{ V}$	dv/dt	50	V/ns
Reverse diode dv/dt, $V_{DS}=0\dots 480\text{ V}$, $I_{SD} \leq I_D$	dv/dt	15	V/ns
Operation and storage temperature	T_{stg}, T_j	-55 to 150	°C

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal resistance, junction-case	$R_{\theta JC}$	4.4	°C/W
Thermal resistance, junction-ambient ⁴⁾	$R_{\theta JA}$	62	°C/W

Electrical Characteristics at $T_j=25^\circ\text{C}$ unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Drain-source breakdown voltage	BV_{DSS}	650			V	$V_{GS}=0\text{ V}$, $I_D=250\text{ }\mu\text{A}$
		700				$V_{GS}=0\text{ V}$, $I_D=250\text{ }\mu\text{A}$, $T_j=150^\circ\text{C}$
Gate threshold voltage	$V_{GS(\text{th})}$	2.9		3.9	V	$V_{DS}=V_{GS}$, $I_D=250\text{ }\mu\text{A}$
Drain-source on-state resistance	$R_{DS(\text{ON})}$		1	1.2	Ω	$V_{GS}=10\text{ V}$, $I_D=2\text{ A}$
			2.7			$V_{GS}=10\text{ V}$, $I_D=2\text{ A}$, $T_j=150^\circ\text{C}$
Gate-source leakage current	I_{GSS}			100	nA	$V_{GS}=30\text{ V}$
				-100		$V_{GS}=-30\text{ V}$
Drain-source leakage current	I_{DSS}			1	μA	$V_{DS}=650\text{ V}$, $V_{GS}=0\text{ V}$

Dynamic Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Input capacitance	C _{iss}		260.7		pF	V _{GS} =0 V, V _{DS} =50 V, f=100 KHz
Output capacitance	C _{oss}		24.1		pF	
Reverse transfer capacitance	C _{rss}		1.2		pF	
Turn-on delay time	t _{d(on)}		29.8		ns	V _{GS} =10 V, V _{DS} =400 V, R _G =2 Ω, I _D =2 A
Rise time	t _r		17.8		ns	
Turn-off delay time	t _{d(off)}		60.3		ns	
Fall time	t _f		14.9		ns	

Gate Charge Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Total gate charge	Q _g		6.7		nC	V _{GS} =10 V, V _{DS} =400 V, I _D =2 A
Gate-source charge	Q _{gs}		1.5		nC	
Gate-drain charge	Q _{gd}		3.2		nC	
Gate plateau voltage	V _{plateau}		5.8		V	

Body Diode Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Diode forward voltage	V _{SD}			1.3	V	I _S =4.5 A, V _{GS} =0 V
Reverse recovery time	t _{rr}		130		ns	V _R =400 V, I _S =2 A, di/dt=100 A/μs
Reverse recovery charge	Q _{rr}		0.92		μC	
Peak reverse recovery current	I _{rrm}		14.7		A	

Note

- 1) Calculated continuous current based on maximum allowable junction temperature.
- 2) Repetitive rating; pulse width limited by max. junction temperature.
- 3) Pd is based on max. junction temperature, using junction-case thermal resistance.
- 4) The value of R_{θJA} is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T_a=25 °C.
- 5) V_{DD}=100 V, V_{GS}=10 V, L=60 mH, starting T_j=25 °C.

Electrical Characteristics Diagrams

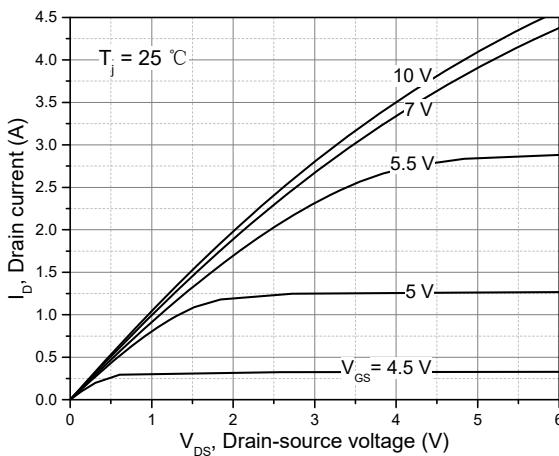


Figure 1. Typ. output characteristics

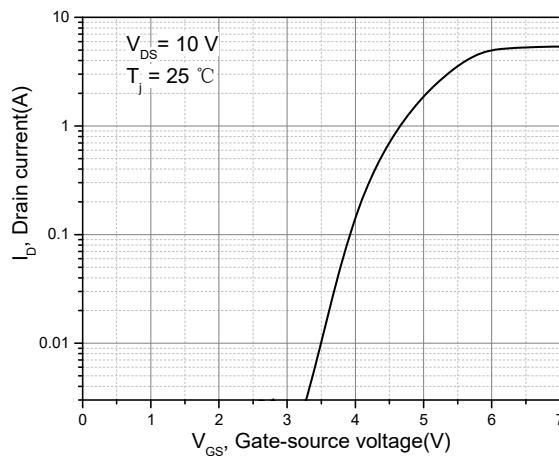


Figure 2. Typ. transfer characteristics

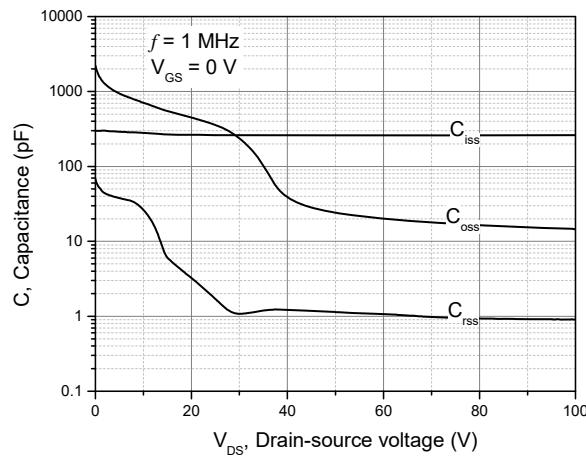


Figure 3. Typ. capacitances

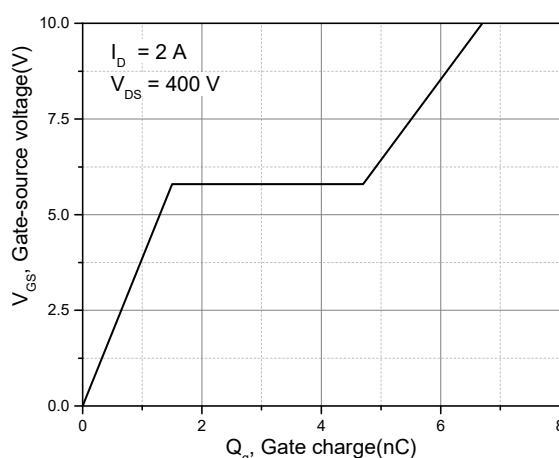


Figure 4. Typ. gate charge

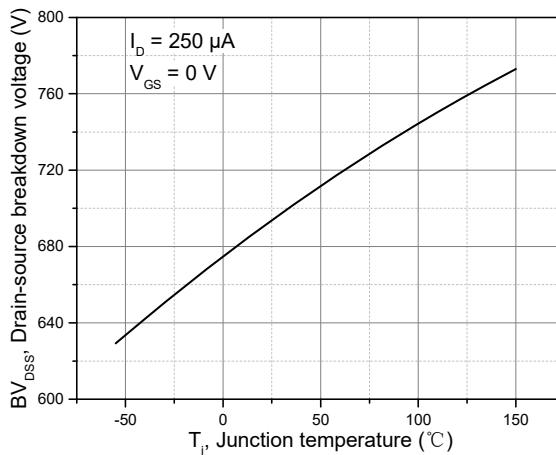


Figure 5. Drain-source breakdown voltage

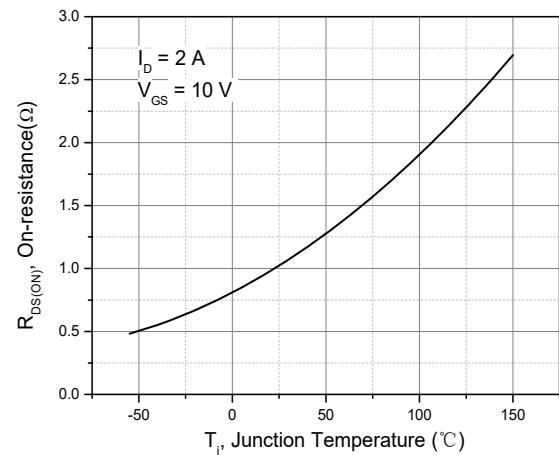


Figure 6. Drain-source on-state resistance

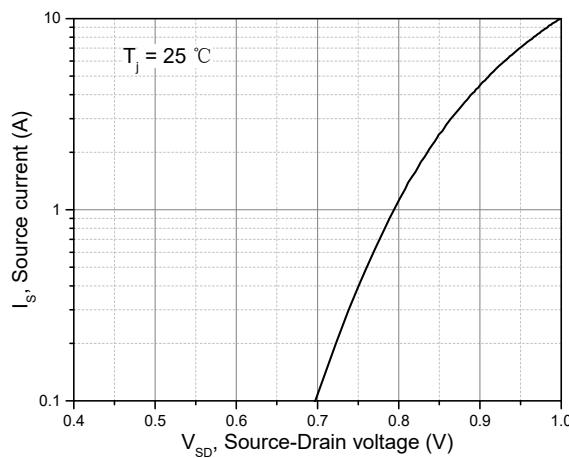


Figure 7. Forward characteristic of body diode

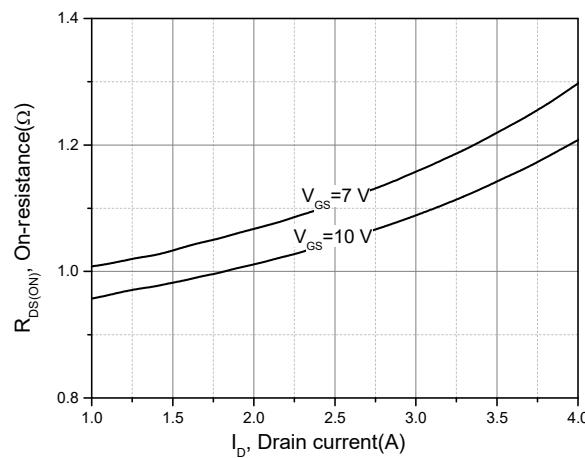


Figure 8. Drain-source on-state resistance

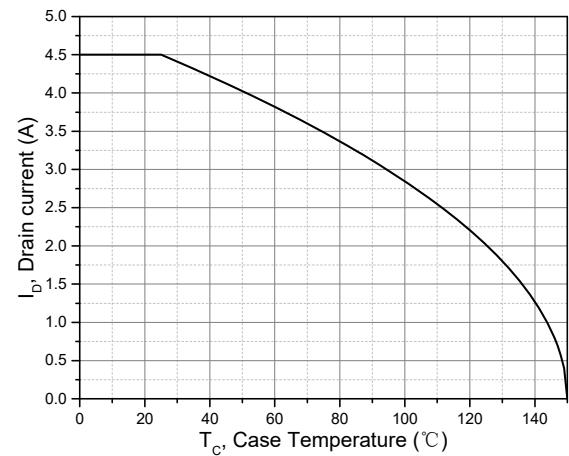


Figure 9. Drain current

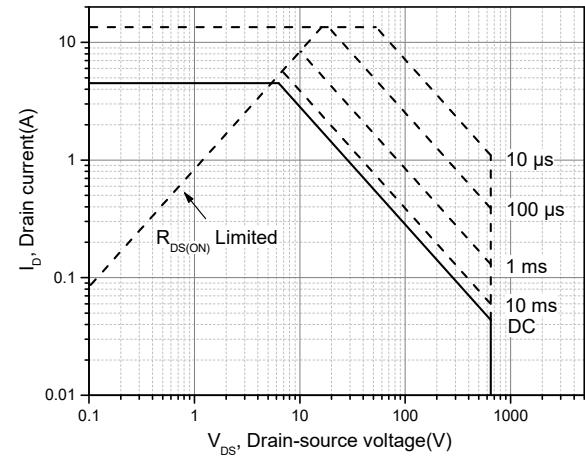


Figure 10. Safe operation area for T_c=25 °C

Test circuits and waveforms

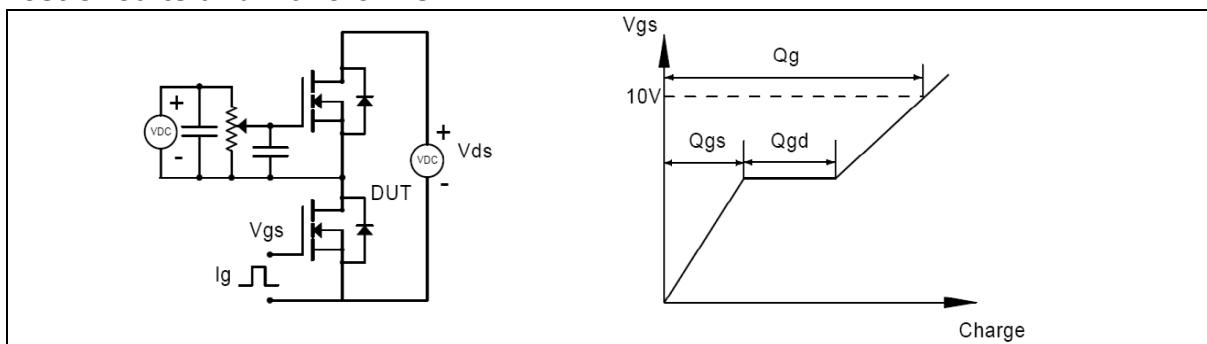


Figure 1. Gate charge test circuit & waveform

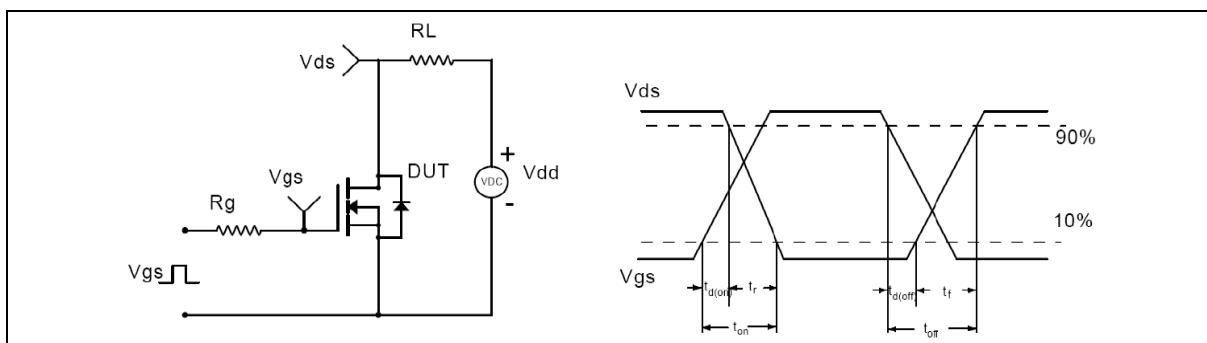


Figure 2. Switching time test circuit & waveforms

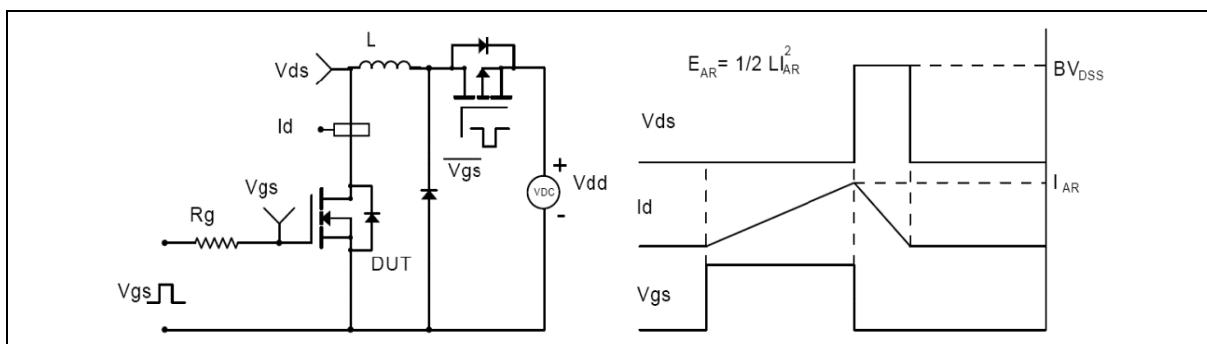


Figure 3. Unclamped inductive switching (UIS) test circuit & waveforms

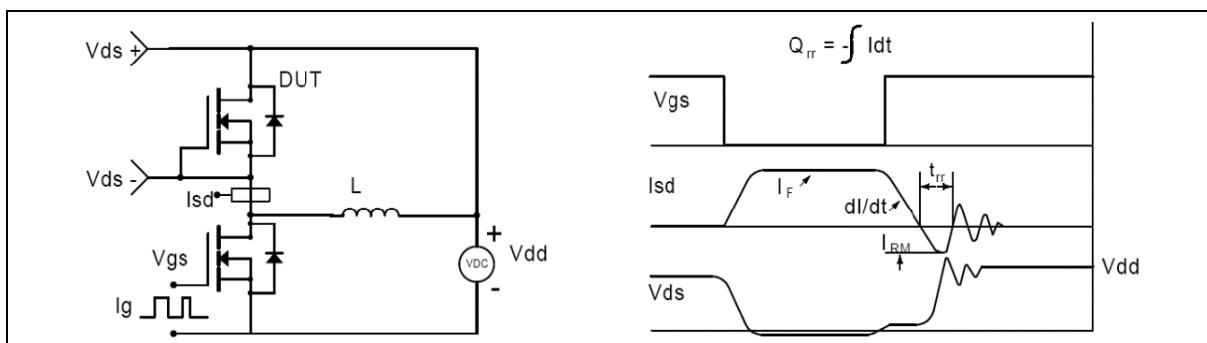
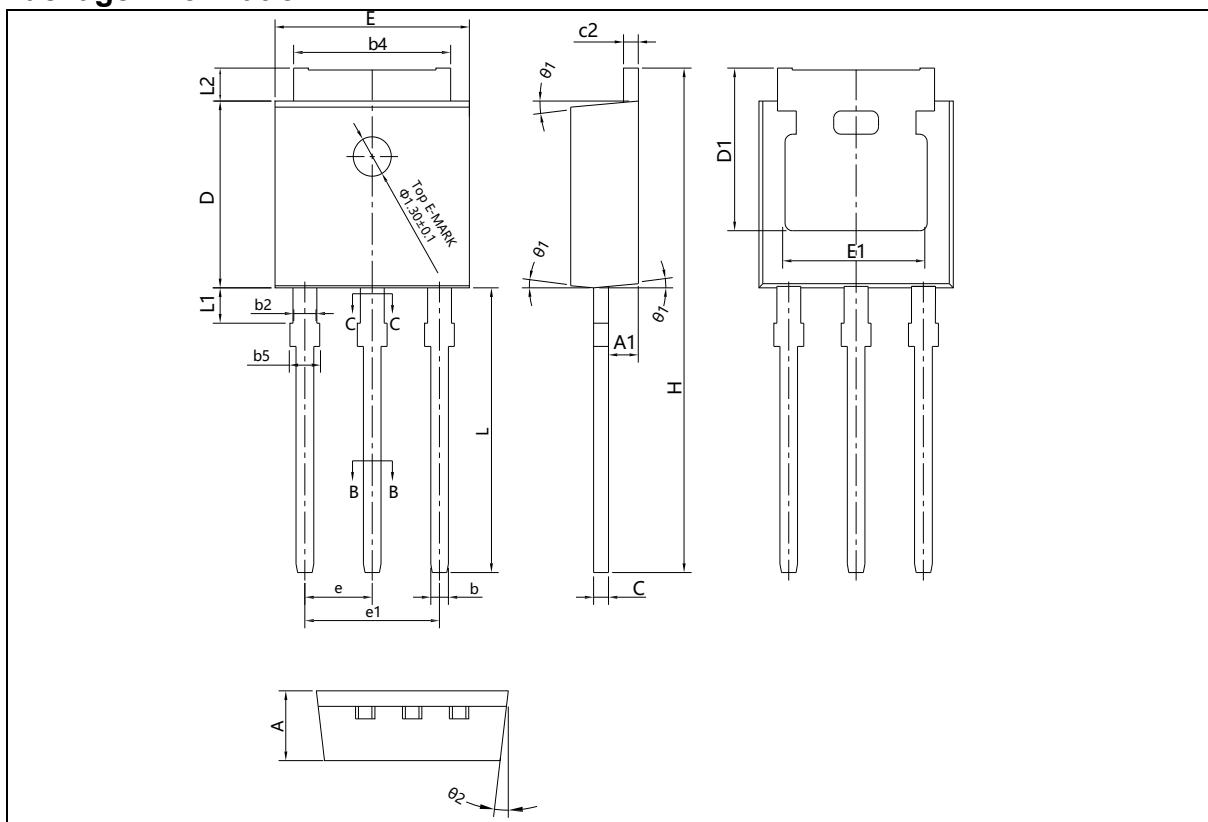


Figure 4. Diode reverse recovery test circuit & waveforms

Package Information



Symbol	mm		
	Min	Nom	Max
A	2.20	2.30	2.35
A1	0.90	1.01	1.10
b	0.56	-	0.69
b1	0.55	0.60	0.65
b2	0.77	-	0.90
b3	0.76	0.81	0.86
b4	5.23	5.33	5.43
b5	-	-	1.05
c	0.46	-	0.59
c1	0.45	0.51	0.55
c2	0.46	-	0.59
D	6.00	6.10	6.20
D1	5.20	-	-
E	6.50	6.60	6.70
E1	4.60	4.83	5.00
e	2.24	2.29	2.34
e1	4.47	4.57	4.67
H	16.18	16.48	16.78
L	9.00	9.30	9.60
L1	0.95	1.16	1.35
L2	0.90	1.08	1.25
θ_1	3°	5°	7°
θ_2	1°	3°	5°

Version 1: TO251-J package outline dimension

Ordering Information

Package Type	Units/Reel	Reels / Inner Box	Units/Inner Box	Inner Box/Carton Box	Units/Carton Box
TO251-J	75	60	4500	5	22500

Product Information

Product	Package	Pb Free	RoHS	Halogen Free
OSG07N65AF	TO251	yes	yes	yes

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